# Microtech Technology Co. Ltd.

### **PRODUCT SPECIFICATIONS**

MODULE NO. : <u>MTF05701DHU-0</u> 1	REVISION : <u>V1.0</u>
DRAWING BY : <u>OSC</u>	DATE : <u>2009-12-24</u>
APPROVED BY :	DATE :
FOR CUSTOMER'S	S APPROVAL
CHECK BY:	DATE :
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ок	NG
COMMENT:	

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# MODEL NO: MTF057010DHU–01 History of Versions and Modifications

Version	Modifications	Date
V1.0	Generation first version	Dec 24,2009

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1. GENERAL SPECIFICATIONS	
1.1 APPLICATION NOTES FOR CONTRO PLEASE REFER TO :	OLLER/DRIVER
HIMAX HX HIMAX HX	
	-
2. MECHANICAL SPECIFICATIONS	
(1) DIAGONALS	
<ul><li>(2) NUMBER OF DOTS</li><li>(3) MODULE SIZE</li></ul>	
(3) MODULE SIZE	(WITHOUT FPC) (MAX) mm
(4) EFFECTIVE AREA	· · · · · · · · · · · · · · · · · · ·
(5) ACTIVE AREA	
	116.2W * 87.4H mm (T/P)
(6) DOT SIZE	0.06W * 0.18H mm
(7) PIXEL SIZE	0.18W * 0.18H mm
(8) LCD TYPE	TFT , TRANSMISSIVE
(9) COLOR	16.7M
(10) VIEWING DIRECTION	12 O'CLOCK
(11) BACK LIGHT	LED , COLOR : WHITE
(12) INTERFACE MODE	RGB 24BIT PARALLEL (DE/SYNC MODE)

#### 3. ABSOLUTE MAXIMUM RATINGS

#### 3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS.

VSS = 0V

P		2			<u>v 55 - 0 v</u>
PARAMETER	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY	VCC	-0.3	7.0	V	
VOLTAGE	VDD	-0.3	7.0	V	
INPUT SIGNAL VOLTAGE	Vi	- 0.3	VCC+0.3	V	
LED BACKLIGHT	PD		1.28	W	
DISSIPATION	FD		1.20	vv	
LED BACKLIGHT	IF		0.06	А	
CURRENT	11'		0.00	A	
LED BACKLIGHT	VR		45	V	
REVERSE VOLTAGE	٧K			v	

#### 3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS.

ITEM	OPERATING		STOF	RAGE	REMARK	
	MIN.	MIN. MAX. MIN. MAX.		KEWAKK		
AMBIENT TEMPERATURE	-10°C	60°C	-20°C	70°C	NOTE (1), (2)	
HUMIDITY	NOT	$\mathbb{E}(2)$	NOT	$\mathbb{E}(2)$	WITHOUT	
	NOTE (3)		NOT	E(3)	CONDENSATION	
VIBRATION		2.45 m/s <sup>2</sup>		11.76 m/s <sup>2</sup>	10~55Hz	
VIDKATION		(0.25 G)		(1.2G)	X,Y,Z,EACH 2HRS	
					6 m SECONDS	
SHOCK		29.4 m/s <sup>2</sup>		490 m/s <sup>2</sup>	XYZ	
SHOEK		(3G)		(50G)	DIRECTIONS	
					3 TIME EACH	
CORROSIVE GAS	NOT ACC	EPTABLE	NOT ACC	EPTABLE		

NOTE (1) : Ta AT  $-20^{\circ}C$ : 48HR MAX.

70°C:168HR MAX.

NOTE (2) : BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT TEMPERATURE THIS PHENOMENON IS REVERSIBLE.

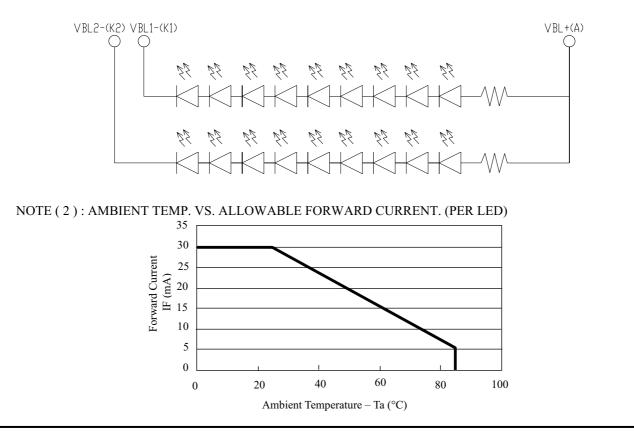
NOTE (3) : Ta  $\leq 60^{\circ}\text{C}$  : 90%RH MAX (96HRS MAX).

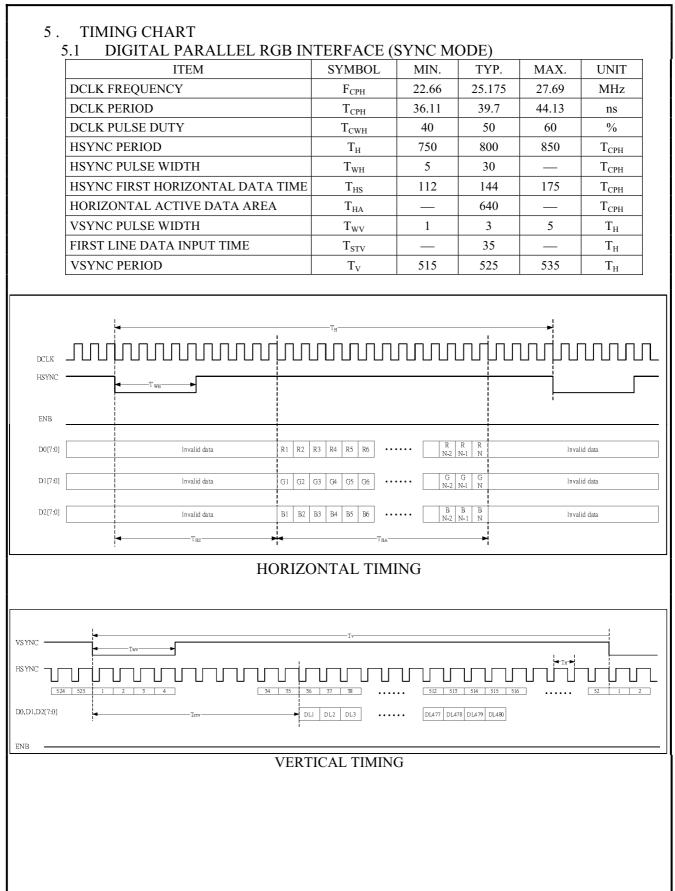
Ta > 60°C : ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY OF 90%RH AT 60°C(96HRS MAX).

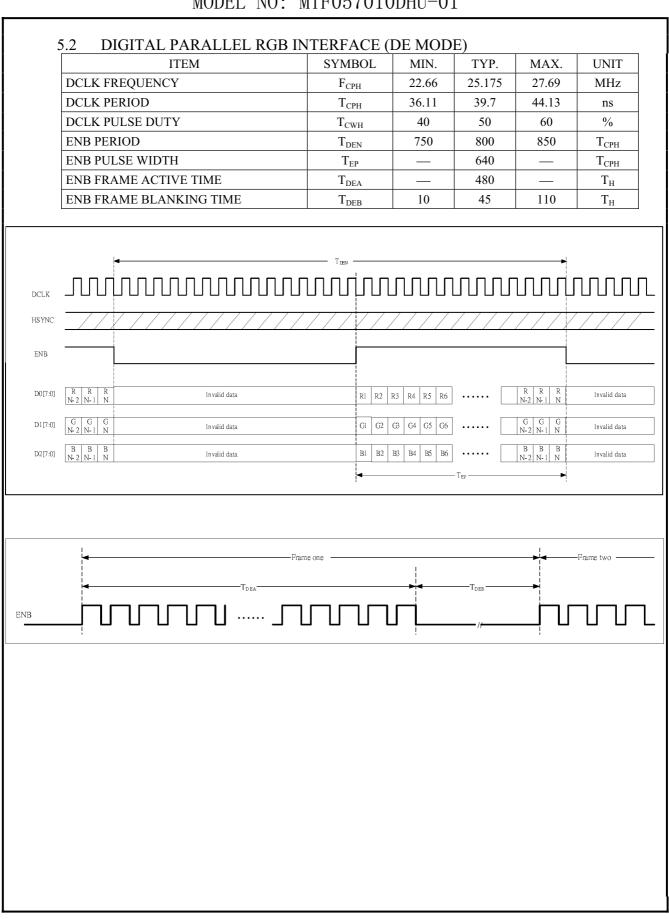
#### 4. ELECTRICAL CHARACTERISTICS

T. LELCIMONE (							$Ta = 25 \circ C$
PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE FOR VCOM	VCC	_	3	3.3	3.6	V	
POWER SUPPLY VOLTAGE FOR LCD	VDD		3	3.3	3.6	V	
POWER SUPPLY CURRENT FOR VOCM	ICC	VCC=3.3V LED B/L=ON		510	600	mA	
POWER SUPPLY CURRENT FOR LCD	IDD	VDD = 3.3V		8	12	mA	
LOW LEVEL INPUT VOLTAGE	VIL		0		0.3*VCC	V	
HIGH LEVEL INPUT VOLTAGE	VIH		0.7*VCC		VCC	V	
OUTPUT LOW VOLTAGE	VOL	$IOL = 400 \mu A$	0		0.2*VCC	V	
OUTPUT HIGH VOLTAGE	VOH	$IOH = -400 \mu A$	0.8*VCC		VCC	V	
FRAME FREQUENCY	fFRAME		50	60	72	Hz	
LED BACKLIGHT FORWARD VOLTAGE	$V_{\rm F}$	I <sub>F</sub> =40mA	28	30	32	V	NOTE (1)
LED LIFE TIME			30000	40000		hr	

NOTE (1): INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT





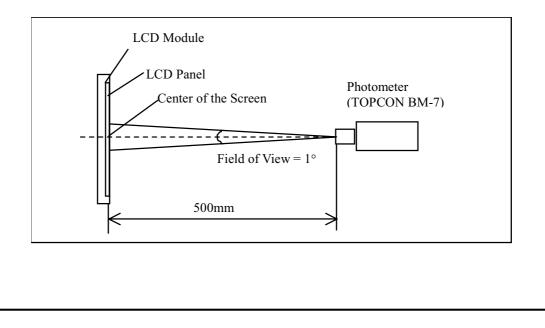


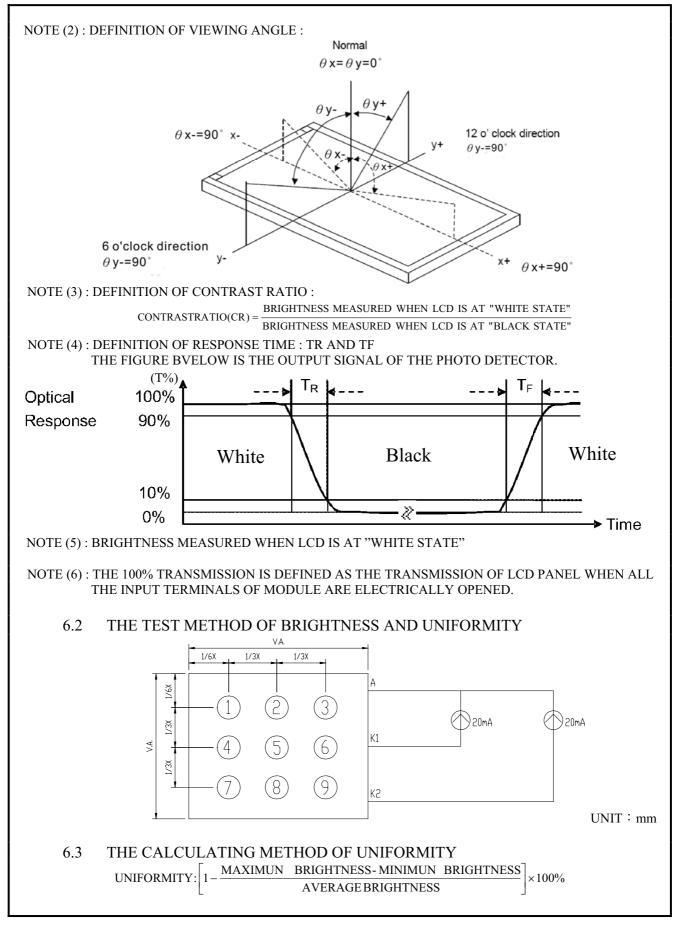
#### 6. OPTICAL CHARACTERISTICS (NOTE1) 6.1 OPTICAL CHARACTERISTICS

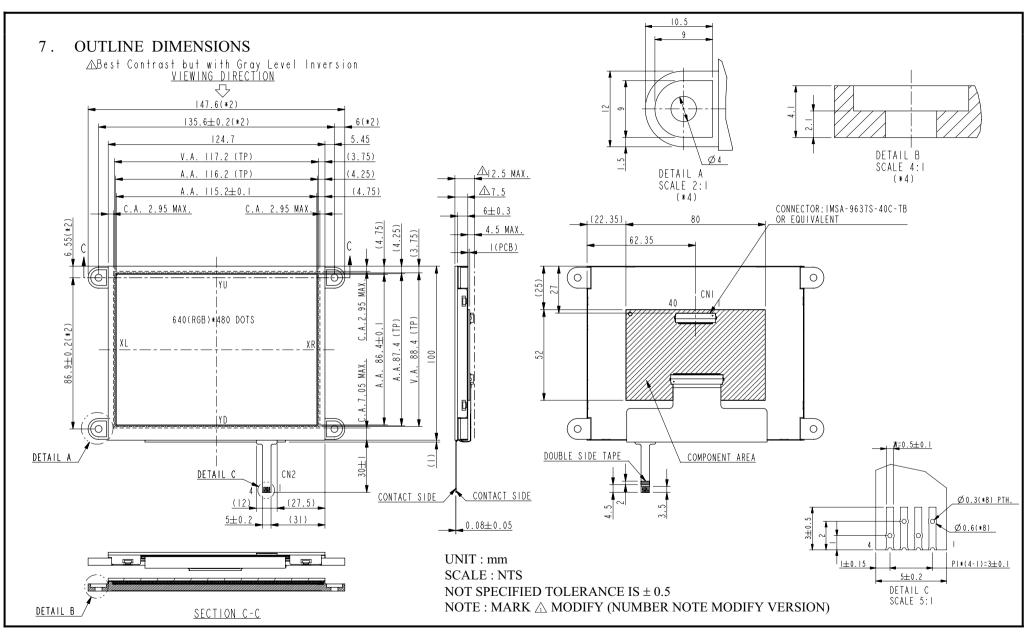
								Ta = 2	5 ± 2 °C
ΙΤΕΜ		SYMBOL	COND	ITION	MIN.	TYP.	MAX.	UNIT	REMARK
VIEWDIC ANCLE		$\theta_{\mathbf{y}^+}$		$\theta_x = 0^\circ$	50	55			
		$\theta_{y}$	$CR \ge 10$		47	52			(2)
	VIEWING ANGLE		$CK \ge 10$	0 -0°	60	65		deg.	(3)
		$\theta_{x}$		$\theta_y=0^{\circ}$	60	65		]	
CONTRAST RAT	ΓΙΟ	CR	θx=0°,	θy=0°	300	350			(3)
RESPONSE TIM	C	T <sub>R</sub> (rise)	$\theta x=0^{\circ}$ ,	000		15	30	maaa	(4)
KESFONSE I IM	E	$T_F(fall)$	0x-0,	<del>0</del> y–0		35	50	msec	
THE BRIGHTNESS OF MODULE		В	$\theta x=0^{\circ}, \ \theta y=0^{\circ}$ IF = 40mA		350	400	_	cd/m <sub>2</sub>	(5)
	WHITE	Wx		$\theta x=0^{\circ}, \ \theta y=0^{\circ}$ IF = 40mA	0.26	0.31	0.36		(6)
		Wy			0.30	0.35	0.40		
	RED	Rx			0.56	0.61	0.66		
COLOR OF CIE	KED	Ry			0.31	0.36	0.41		
COORDINATE	CDEEN	Gx	$\begin{bmatrix} 1F = 2 \\ NTSC \end{bmatrix}$		0.28	0.33	0.38		
COORDINATE	GREEN	Gy			0.51	0.56	0.61		
	DLUE	Bx			0.09	0.14	0.19		
	BLUE	Ву	1		0.07	0.12	0.17	1 —	
THE UNIFORMITY OF MODULE			IF = 4	40mA	75	80		%	

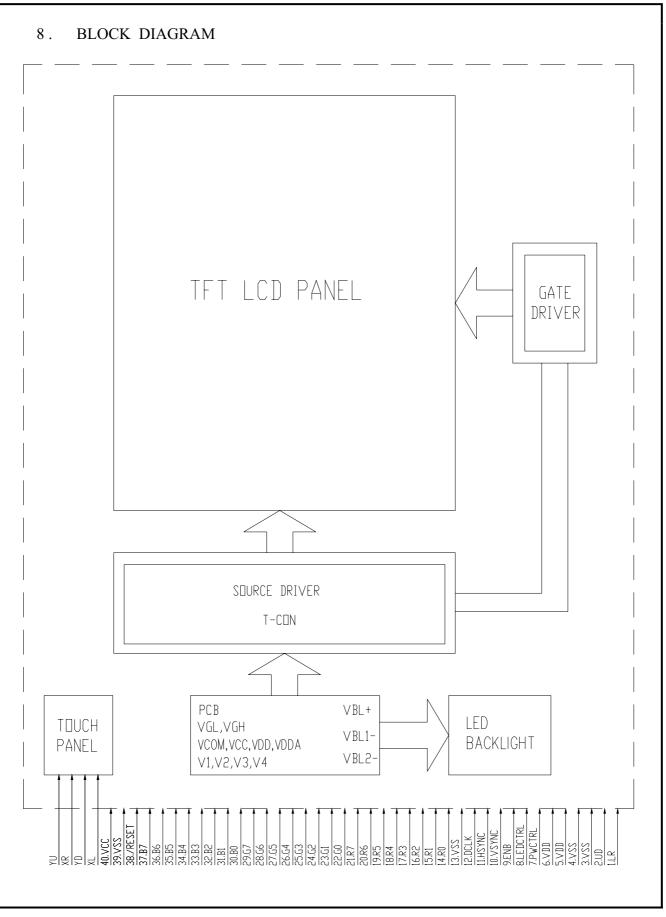
#### NOTE (1) : TEST EQUIPMENT SETUP :

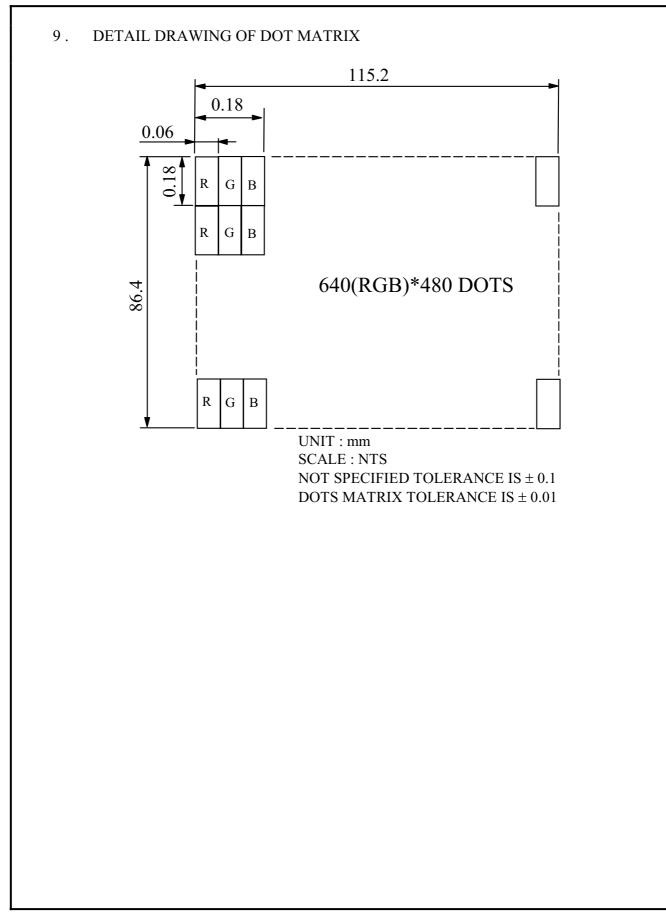
AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES, THE MEASUREMENT SHOULD BE EXECUTED. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF 1° AT A DISTANCE OF 50cm AND NORMAL DIRECTION.









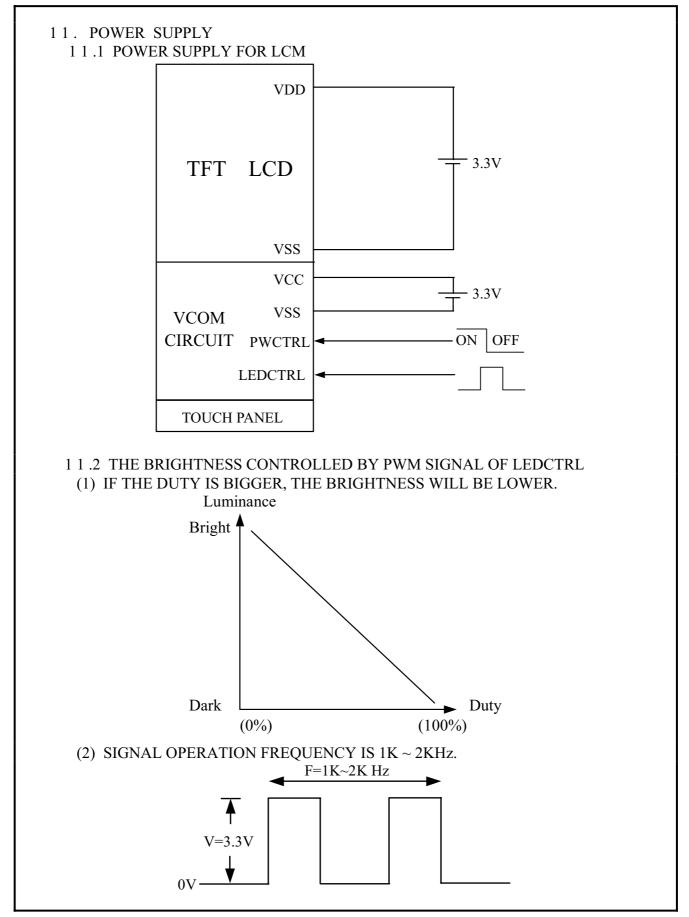


PIN NO	SYMBOL	I/O			FUNCTION	
1	LR	Ι	LR=H ∶ STH→S01→			
1		-	$LR=L$ : STH $\rightarrow$ S960 $\rightarrow$		$1 \rightarrow \text{STHO}$	
2	UD	Ι	UP/DOWN SCAN SET UD=H, REVERSE SC.			
2		1	UD=L, NORMAL SCA			
3,4	VSS	Р	GROUND			
5	VDD	Р	POWER SUPPLY FOR DIGITAL CIRCUIT			
6	VDD	Р	POWER SUPPLY FOR	R DIGITAI	L CIRCUIT	
				PV	WCTRL	REMARK
					Н	POWER ON
7	PWCTRL	Ι	$\begin{array}{c} \text{LOGIC LEVEL} \\ \text{H} = 3.3 \text{V} \end{array}$		11	TOWERON
			L=0V		L	SHUTDOWN
0	LEDCEDI	т				
8	LEDCTRL	I	BRIGHTNESS CONT			SYNC MODE SETTING
9	ENB	Ι	DATA ENABLE INPU			ONLY ENB AND PIXEL
10	VSYNC	Ι	CLOCK IS NECESSARY. VERTICAL SYNC INPUT SYNC MODE : ENB SHOULD BE			
						CONNECTED TO VSS.
11	HSYNC	Ι	HORIZONTAL SYNC INPUT HSYNC/YSYNC AND PIXEL CLOCK IS NECESSARY.			
12	DCLK	Ι	DOT DATA COLOCK			
13	VSS	Р	GROUND			
14	R0	Ι	RED DATA BIT 0			
15	R1	Ι	RED DATA BIT 1			
16	R2	Ι	RED DATA BIT 2			
17	R3	Ι	RED DATA BIT 3			
18	R4	Ι	RED DATA BIT 4			
19	R5	Ι	RED DATA BIT 5			
20	R6	Ι	RED DATA BIT 6			
21	R7	Ι	RED DATA BIT 7			
22	G0	Ι	GREEN DATA BIT 0			
23	G1	Ι	GREEN DATA BIT 1			
24	G2	Ι	GREEN DATA BIT 2			
25	G3	Ι	GREEN DATA BIT 3			
26	G4	Ι	GREEN DATA BIT 4			
27	G5	Ι	GREEN DATA BIT 5			
28	G6	Ι	GREEN DATA BIT 6			
29	G7	Ι	GREEN DATA BIT 7			
30	B0	Ι	BLUE DATA BIT 0			
31	B1	Ι	BLUE DATA BIT 1			

PIN NO	SYMBOL	I/O	FUNCTION
32	B2	Ι	BLUE DATA BIT 2
33	B3	Ι	BLUE DATA BIT 3
34	B4	Ι	BLUE DATA BIT 4
35	B5	Ι	BLUE DATA BIT 5
36	B6	Ι	BLUE DATA BIT 6
37	B7	Ι	BLUE DATA BIT 7
38	/RESET	Ι	HARDWARE RESET
39	VSS	Р	GROUND
40	VCC	Р	POWER SUPPLY FOR VCOM DRIVER CIRCUIT

#### T/P INTERFACE

PIN NO	SYMBOL	FUNCTION
1	YU	TOP PANEL
2	XR	RIGHT PANEL
3	YD	BOTTOM PANEL
4	XL	LEFT PANEL



#### 12. TOUCH PANEL SPECIFICATION 12.1 ELECTRICAL CHARACTERISTICS

			$Ta = 25^{\circ}C$
ITEM	CONDITION	SPEC.	UNIT
LINEARITY		≤ 1.5	%
TRANSMISSION	ASTM D1003	80 OR MORE	%
ON LOAD	POLYACETAL PEN INPUT	15 ~ 80	g
TERMINAL RESISTANCE	X AXIS	$400 \sim 1000$	Ω
I ERIVIINAL RESISTANCE	Y AXIS	$200 \sim 700$	52
INSULATION RESISTANCE	DC25V	≥ 10	MΩ
INPUT VOLTAGE		5	V

#### **12.2 PRECAUTIONS IN USE OF TOUCH PANEL**

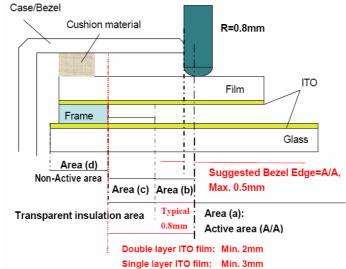
#### 12.2.1 PURPOSE :

IN ORDER TO PREVENT ACCIDENTAL USE AND PERFORMANCE DETERIORATION, PLEASE KEEP THE FOLLOWING PRECAUTIONS AND INHIBITED POINTS.

#### 12.2.2 ITEM AND ILLUSTRATION :

#### (1) STRUCTURE, AREA DEFINITION

THE STRUCTURE AND THE PERFORMANCE GUARANTEED AREA OF THIS TOUCH PANEL ARE DEFINED BELOW :



THE ABOVE FIGURE IS OUR DESIGN RULE OF TOUCH PANEL. IF IT CANNOT MEET YOUR REQUIREMENT, PLEASE CONTACT WITH OUR ENGINEERS FOR FURTHER DISCUSSION.

ABOVE FIGURE ILLUSTRATES THE RECOMMENDED BEZEL AND CUSHION DESIGN. IN ORDER TO PREVENT UNUSUAL PERFORMANCE DEGRADATION AND MALFUNCTION OF A TOUCH PANEL, PLEASE CARRY OUT THE SET CASE DESIGNING AND A TOUCH PANEL ASSEMBLING METHOD AFTER SURELY CONSIDERING THE DEFINITION OF EACH AREA ILLUSTRATED IN ABOVE FIGURE.

AREA(a) : ACTIVE AREA THE ACTIVE AREA IS GUARANTEED THE POSITION DATA DETECTABLE PRECISION, OPERATION FORCE AND OTHER OPERATIONS. IT IS STRONGLY RECOMMENDED TO PLACE THE OPERATION BUTTON OR MENU KEYS WITHIN THE ACTIVE AREA. DUE TO STRUCTURE, THE ACTIVE AREA IS LESS DURABLE AT THE EDGE OR CLOSE TO THE EDGE.

AREA(b) : OPERATION NON-GUARANTEED AREA THIS AREA DOES NOT GUARANTEE A TOUCH PANEL OPERATION AND ITS FUNCTION. WHEN THIS AREA IS PRESSED, TOUCH PANEL SHOWS DEGRADATION OF ITS PERFORMANCE AND DURABILITY SUCH AS A PEN SLIDING DURABILITY BECOMES ABOUT ONE-TENTH COMPARED WITH THE ACTIVE AREA (AREA-(A) AS GUARANTEED AREA) AND ITS OPERATION FORCE REQUIRES ABOUT DOUBLE. ABOUT 0.5 MM OUTSIDE FROM A BOUNDARY OF THE ACTIVE AREA CORRESPONDS TO THIS AREA.

AREA(c) : PRESSING PROHIBITION AREA THE AREA WHICH FORBIDS PRESSING, BECAUSE AN EXCESSIVE LOAD IS APPLIED TO A TRANSPARENT ELECTRODE (ITO) AND A SERIOUS DAMAGE IS GIVEN TO A TOUCH PANEL FUNCTION BY PRESSING.

- AREA(d) : NON-ACTIVE AREA THE AREA DOES NOT ACTIVATE EVEN IF PRESSED.
- (2) CAUTIONS FOR INSTALLING AND ASSEMBLING (i) DO NOT GIVE EXCESSIVE STRAIN TO THE PRODUCT.

( ii ) FLEXIBLE PATTERN CABLE IS CONNECTED TO THE BODY BY THERMAL PRESSURE METHOD. SO, DO NOT APPLY EXCESSIVE FORCES TO THE FLEXIBLE PATTERN. DO NOT ADD AN EXCESSIVE FORCE TO A FPC(FLEX TAIL) THAT MAKES PEELING OFF OF THE FPC FROM THE PRODUCT. DO NOT FIX, ADHERE OR MOUNT ANY ADDITIONAL GOODS ON THE FPC SUCH AS ADDITIONAL FILM/PLATE ON THE FPC, BECAUSE SUCH ADDITIONAL GOODS WILL APPLY A STRESS AT THE FPC BONDING AREA. IT MAY AFFECT THE CONDUCTIVITY OF FPC WITH TOUCH PANEL.

( iii ) IN ORDER NOT TO APPLY LOAD ON THE DISPLAY, PROVIDE A CLEARANCE OF AT LEAST 0.3MM BETWEEN THE PRODUCT AND DISPLAY.

(iv) WE RECOMMEND THE DESIGN OF A CASE OR BEZEL SHOULD COVERS THE BOUNDARY OF THE ACTIVE AREA INSIDE IN ORDER TO PREVENT AN OPERATION AT OUTSIDE OF THE ACTIVE AREA WHICH CAN NOT GUARANTEE THE FUNCTION OR DURABILITY (REFER TO ITEM 5.1.2. STRUCTURE, AREA DEFINITION).
BEZEL'S EDGE PART MAY GUIDE THE PEN SLIDING ON THE SAME POSITION REPEATEDLY. IF THE BEZEL IS PLACED OUTSIDE OF THE ACTIVE AREA, IT MAY CAUSE THE DAMAGE OF THE ITO FILM.

(v) PRESSING INSIDE OF BOUNDARY OF THE FRAME(PART (A) AS SHOWN IN BELOW) MAY CAUSES FAULT OPERATION, SO PLEASE DESIGN TO AVOID PRESSING OF TOUCH PANEL AT PART (A) SUCH AS HAVING GASKET/CUSHION AT PART (C). PARTICULARLY THE AREA (B) SHALL BE FREE FROM BURR. THE GASKET/CUSHION MATERIAL AT THE PART (C) SHOULD NOT BE EXCEEDED TO INSIDE OF THE BOUNDARY OF THE FRAME. Case/Bezel **Cushion material** С Film JTO Frame Glass Out of Active area Active area (vi) TO PREVENT GIVING DISTORTION TO THE FILM OF THE PRODUCT AND PEELING OFF OF THE FILM FROM THE PRODUCT, DO NOT FIX THE FILM AND A SET CASE OR A SHOCK ABSORBING MATERIAL ADHERED TO A SET CASE BY ADHESION. (vii) WIPE OFF THE STAIN ON THE PRODUCT BY USING SOFT CLOTH MOISTENED WITH ETHANOL. TAKE CARE NOT TO ALLOW ETHANOL TO SOAK INTO THE JOINT OF UPPER FILM AND BOTTOM GLASS. IT MAY OTHERWISE CAUSE PEELING OR DEFECTIVE OPERATION. DO NOT USE ANY ORGANIC SOLVENT OR DETERGENT OTHER THAN ETHANOL. (viii) THE CORNERS OF THE PRODUCT ARE NOT CHAMFERED AND ARE SHARP. WHEN POSITIONING AND FIXING THE PRODUCT ON THE CASE, PROVIDE A ROUND PART ON THE CORNER OF THE CASE SO AS NOT TO APPLY LOAD ON THE CORNER OF THE TRANSPARENT TOUCH PANEL. (ix) DO NOT PRESS THE FILM OF THE PRODUCT WHEN THIS PRODUCT IS BUILT INTO A SET. (3) CAUTIONS FOR OPERATION (i) OPERATE IT WITH A POLYACETAL PEN (TIP R0.8 OR OVER) OR A BELLY OF A FINGER WITHOUT APPLYING EXCESSIVE LOAD. NEVER USE ANY MECHANICAL PENCILS, BALL POINT PENS AND HARD FINGERTIPS WHOSE TIP IS HARD FOR INPUT, OTHERWISE MALFUNCTIONS MAY RESULT.

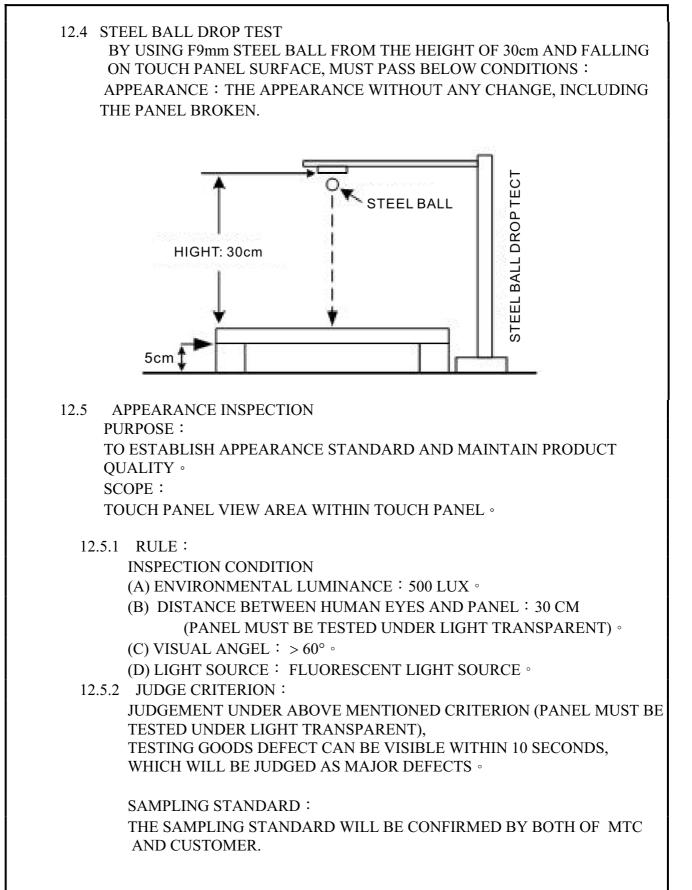
- (ii) THE INPUT POSITION MAY BE FLUCTUATED A LITTLE THROUGH LONG-TIME USE. IT IS DESIRABLE TO PROVIDE A ZERO-ADJUSTMENT FUNCTION BY USING A CIRCUIT AND SOFTWARE.
- (iii) OPERATION AT THE OUT OF ACTIVE AREA IS OUT OF OUR GUARANTEE. IT CAUSES A SERIOUS DAMAGE OF A TRANSPARENT ELECTRODE. DO NOT OPERATE AT THE OUT OF ACTIVE AREA.

(iv) IN CASE OF CLEANING THE PART OF THE CASE BOUNDARY OF ACCOMPLISHED SET, USE A SOFT CLOTH WITH A FINGER BERRY OR A COTTON BUD. DO NOT CLEAN WITH A THI NG OTHER THAN THE FINGER SUCH AS HARD OR SHARP EDGES LIKE A FINGER NAIL ETC. ON THE CLOTH, BECAUSE IT CAUSE TRANSPARENT CONDUCTIVE FILM CRACKS. PLEASE ADVISE THIS PROHIBITION TO YOUR LAST CUSTOMERS.

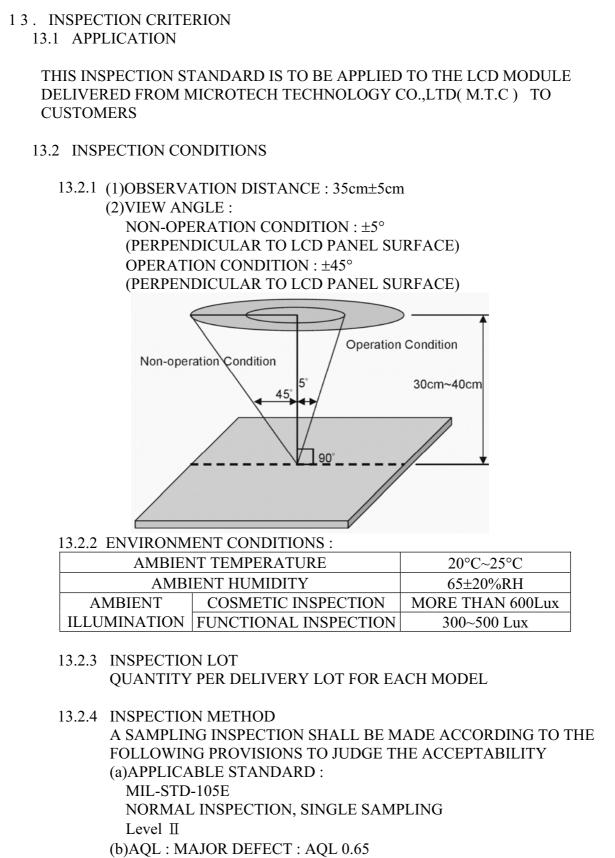
12.3 DURABILITY

12.3.1 STYLUS HITTING : ONE MILLION TIMES OR OVER NO DAMAGE ON FILM SURFACE PEN : R8 mm SILICON RUBBER LOAD : 250g FREQUENCY : 240 times/min MEASUREMENT POSITION: 1 POINT OF TOUCH PANEL ACTIVE AREA REPEATED : OVER 1,000,000 TIMES

12.3.2 PEN TOUCH SLIDING DURABILITY : 100,000 TIMES OR OVER WRITING WITH R0.8mm PLASTIC STYLUS PEN; WRITING FORCE 150g IN ACTIVE AREA. SPEED IS 60mm/sec.



INSPECTION ITEMS	SEPC.		JUDGE CRITERION	OPERATION GUIDELINE	
SCRATCH	$W \le 0.05 mm \& L \le 10 mm$		ACCEPTABLE	REFL	
SCRATCH	W > 0.05mm or L > 10mm		NOT ACCEPTABLE	BACK GROUND TESTING GOODS	
LINEAR FOREIGN	$W \le 0.05 \text{mm} \& L \le 5 \text{mm}$		ACCEPTABLE	FLUORESCENT LIGHT SOURCE	
OBJECT	W > 0.05mm or L >5mm		NOT ACCEPTABLE	60° ENVIRONMENTAL IUMINANCE : 500Lux	
	$D \le 0.25 mm$		ACCEPTABLE		
GRANULAR FOREIGN OBJECT	0.25mm < D ≤0.30mm		MAX. 2 EA	REFL FLUORESCENT LIGHT SOURCE TESTING GOODS	
	D >0.30mm		NOT ACCEPTABLE	60 <sup>°</sup> ENVIRONMENTAL IUMINANCE : 500Lux	
PET BUBBLES	D ≤0.5mm		ACCEPTABLE		
TET DODDLES	D >0.5mm		NOT ACCEPTABLE		
CHIP ON GLASS	CORNER	$X \le 3mm \land$ Y \le 3mm \la Z < t (t = /thickness)	ACCEPTABLE	Chip of glass	
	EDGE	$W \le 3mm \times Y \le 3mm \times Z < t$		x x x	



MINOR DEFECT : AQL 1.0

#### 13.3 INSPECTION STANDARDS

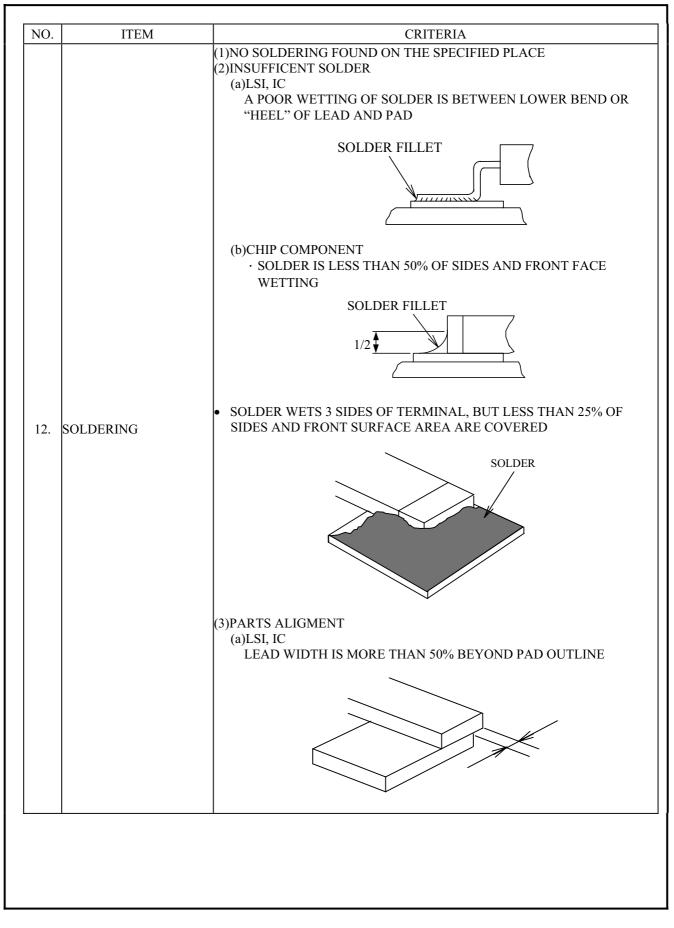
#### 13.3.1 VISUAL DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL	
	1.DISPLAY ON	• DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS EX: DISCONNECTION, SHORT CIRCUIT ETC		
MAJOR DEFECT	2.BACKLIGHT	<ul> <li>NO LIGHT</li> <li>FLICKERING AND OTHER ABNORMAL ILLUMINATION</li> </ul>	- 0.65	
	3.DIMENSIONS	• SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS		
	1.DISPLAY ZONE	<ul> <li>BLACK/WHITE SPOT</li> <li>BUBBLES ON POLARIZER</li> <li>NEWTON RING</li> <li>BLACK/WHITE LINE</li> <li>SCRATCH</li> <li>CONTAMINATION</li> <li>LEVER COLOR SPREED</li> </ul>		
MINOR DEFECT	DEFECT 2.BEZEL ZONE	• STAINS • SCRATCHES • FOREIGN MATTER	1.0	
	3.SOLDERING	<ul> <li>INSUFFICIENT SOLDER</li> <li>SOLDERED IN INCORRECT POSITION</li> <li>CONVEX SOLDERING SPOT</li> <li>SOLDER BALLS</li> <li>SOLDER SCRAPS</li> </ul>		
	4.DISPLAY ON (ALL ON)	• LIGHT LINE		

#### 13.3.2 MODULE DEFECTS CALSSIFICATION

NO.	ITEM	CRITERIA			
1.	DISPLAY ON INSPECTION	<ul> <li>(1)INCORRECT PATTERN</li> <li>(2)MISSING SEGMENT</li> <li>(3)DIM SEGMENT</li> <li>(4)OPERATING VOLTAGE BEYOND SPEC</li> </ul>			
2.	OVERALL DIMENSIONS	(1)OVERALL DIM	(1)OVERALL DIMENSION BEYOND SPEC		
3.	DOT DEFECT	AND BLUE SC (2) I BRIGHT DOT DARK DOT TOAL BRIGHT NOTE : 1. THE DEFINITIC THE SIZE OF A REGARDED AS 2. BRIGHT DOT : DOTS APPEAR PANEL IS DISP 3. DARK DOT :	REENS. TEMS AND DARK DOTS N OF DOT : DEFECTIVE DOT ONE DEFECTIVE BRIGHT AND UN LAYING UNDER I	OVER 1/2 OF WHOLE	NT E DOT IS
				PURE RED, GREEN, B	
4.	FOREIGN BLACK/WHITE/ BRIGHT LINE/	$\begin{array}{c} L \leq 0.3 \\ \hline 0.3 < L \leq 2.5 \end{array}$	$W \le 0.05$ $0.05 < W \le 0.1$	IGNORE 4	
	SCRATCH OF VIEWING AREA	2.5 < L WIDTH : W mm, 1	0.1 < W	NONE	
		AVERAGE DIA	METER (mm): D 0.15	NUMBER OF PIECES IGNORE	
	FOREIGN MATTER \ BLACK SPOTS \		D ≤ 0.5 < D	4 NONE	
5.	WHITE SPOTS \ DENT (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)		TER D=(a+b)/2		

NO.	ITEM	CRITERIA			
			AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED	
			D ≤ 0.25	IGNORE	
		BUBBLE ON THE	0.25 < D ≤ 0.5	N ≤ 5	
		POLARIZER	0.5 < D	NOTE	
			D < 0.1 mm	IGNORE	
		SURFACE STATUS	$0.1 < D \le 0.3$ mm	$N \leq 3$	
		CF FAIL / SPOT	D < 0.1 mm	IGNORE	
		CF FAIL / SFOT	$0.1 < D \le 0.3$ mm	$N \leq 3$	
	BUBBLES OF POLARIZER /DIRT/CF FAIL /SURFACE STAINS	NOTE : (1)POLARIZER BUBBLE IS DEFINED AS THE BUBBLE APPEARS ON ACTIVE DISPLAY AREA. THE DEFECT OF POLARIZER BUBBLE SHALL BE IGNORED IF THE POLARIZER BUBBLE APPEARS ON THE OUTSIDE OF ACTIVE DISPLAY AREA. (2)THE EXTRANEOUS SUBSTANCE IS DEFINED AS IT CAN BE OBSERVED WHEN THE MODULE IS POWER ON. (3)THE DEFINITION OF AVERAGE DIAMETER, D IS DEFINED AS FOLLOWING. AVERAGE DIAMETER (D)=(a+b)/2			
7.	LINE DEFECT ON DISPLAY	OBVIOUS VERTICA	L OR HORIZONTAL LINE	DEFECT IS NOT ALLOW	
8.	MURA ON DISPLAY	IT'S OK IF MURA IS SLIGHT VISIBLE THROUNG 6% ND FILTER			
9.	UNEVEN COLOR SPREAD, COLORATION	(1)TO BE DETERMINED BASED UPON THE STANDARD SAMPLE.			
10.	BEZEL APPEARANCE	<ul> <li>(1)BEZEL MAY NOT HAVE RUST, BE DEFORMED OR HAVE FINGER</li> <li>PRINTS STAINS OF OTHER CONTAMINATION.</li> <li>(2)BEZEL MUST COMPLY WITH JOB SPECIFICATIONS.</li> </ul>			
11	<ul> <li>(1)THERE MAY NOT BE MORE THAN 2mm OF SEALANT OUTSIDE THE SEAL AREA ON THE PCB, AND THERE SHOULD BE NO MORE THAN THREE PLACES.</li> <li>(2)NO OXIDATION OR CONTAMINATION PCB TERMINALS.</li> <li>(3)PARTS ON PCB MUST BE THE SAME AS ON THE PRODUCTION CHARACTERISTIC CHART</li> </ul>				



NO.   ITE	M CRITERIA
	(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE
12. SOLDERING	
	<ul> <li>(4)NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB.</li> <li>(5)NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE.</li> <li>(6)NO RESIDUE OR SOLDER BALLS ON PCB.</li> <li>(7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.</li> </ul>
13. BACKLIGHT	<ul> <li>(1)NO LIGHT</li> <li>(2)FLICKERING AND OTHER ABNORMAL ILLUMINATION</li> <li>(3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGE USING LCD SPOT, LINES AND CONTAMINATION STANDARDS.</li> <li>(4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.</li> </ul>
14. GENERAL APPEARANO	<ul> <li>(1)NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP.</li> <li>(2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP.</li> <li>(3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT.</li> <li>(4)THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS.</li> <li>(5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THI INTERFACE PIN TO SEVER.</li> <li>(6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING</li> <li>(COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR.</li> <li>(7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED.</li> <li>(8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET.</li> <li>(9)LCD PIN LOOSE OR MISSING PINS.</li> <li>(10)PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET.</li> <li>(11)PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET.</li> <li>(12)THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY DIRT AND BREAK.</li> </ul>

NO.	ITEM	CRITERIA		
		THE LCD WITH EXTENSIVE (	CRACK IS NOT ACCEPTABLE	
		GENERAL GLASS CHIP :	abc $\leq t/2$ $<$ VIEWING AREA $\leq 1/8X$ $t'2 > , \leq 2t$ $\leq W/2$ $\leq 1/8X$ *W=DISTANCE BETWEEN SEALANT AREA AND LCD PANEL EDGE X = LCD SIDE LENGTH t = GLASS THICKNESS	
15. CRACKED GLASS	CORNER PART :	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$		
		CHIP ON ELECTRODE PAD	$\begin{tabular}{ c c c c c c } \hline a & b & c \\ \hline \leq t & \leq 0.5 mm & \leq 1/8X \\ \hline * X = LCD SIDE WIDTH \\ t = GLASS THICKNESS \\ \hline \end{tabular}$	
		c a	abc $\leq t$ $\leq 1/8X$ $\leq L$ *X=LCD SIDE WIDTH $t = GLASS THICKNESS$ t=ELECTRODE PAD LENGTH $\bigcirc$ IF GLASS CHIPPING THE ITOTERMINAL, OVER 2/3 OF THE ITO MUSREMAIN AND BE, INSPECTEDACCORDING TO ELECTRODETERMINAL SPECIFICATIONS $\oslash$ IF THE PRODUCT WILL BE HEATSEALED BY THE CUSTOMER,THE ALIGNMENT MARK MUST NOTBE DEMAGED	

#### 13.4 RELIABILITY TEST

#### 13.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO	ITEM	DESCRIPTION	
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +60°C FOR 240 HRS	
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -10°C FOR 240 HRS	
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS	
4	LOW TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS	
5	HIGH TEMP / HUMIDITY TEST STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS	
6	THERMAL SHOCK (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION: -40°C FOR 30 MINUTES ~ +80°C FOR 30 MINUTES	
7	ESD (ELECTROSTATIC DISCHARGE ) (NOT OPERATED)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV	

NOTE (1) : THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

#### 13.5 TESTING CONDITIONS AND INSPECTION CRITERIA

FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 12.5, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

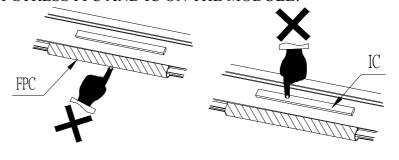
NO	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION		THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

#### 13.6 OPERATION

- 13.6.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 13.6.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE ; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY ; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR. WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY .
- 13.6.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST .
- 13.6.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND

REACHES THE SPECIFIED VALUE . IF ABOVE SEQUENCE IS NOT FOLLOWED , CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH - UP PROBLEM .

13.6.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS! DO NOT STRESS FPC AND IC ON THE MODULE!



#### 13.7 NOTICE

- 13.7.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING , TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGH-HOLE-PAD .
- 13.7.2 DO NOT DISASSEMBLE . MTC SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED .
- 13.7.3 DO NOT CHARGE STATIC ELECTRICITY , AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP . WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL .
- 13.7.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE ; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED

DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE .

- 13.7.5 DON'T GIVE EXTERNAL SHOCK.
- 13.7.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 13.7.7 LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC. WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 13.7.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 13.7.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.
- 13.7.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 13.7.11 REWIRING: NO MORE THAN 3 TIMES.